

## DFNWB2\*2-6L-A Plastic-Encapsulate MOSFETS

CJMP06 P-Channel Power MOSFET

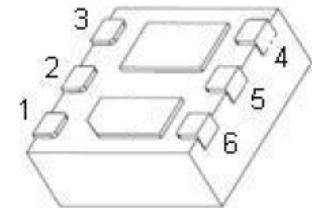
### FEATURE

- Featuring a MOSFET and Schottky Diode
- Independent Pinout to each Device to Ease Circuit Design
- Ultra Low  $V_F$  Schottky

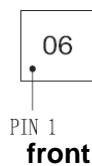
### APPLICATIONS

- Li-Ion Battery Charging
- High Side DC-DC Conversion Circuits
- High Side Device for Small Brushless DC Motors
- Power Management in Portable , Battery Powered Products

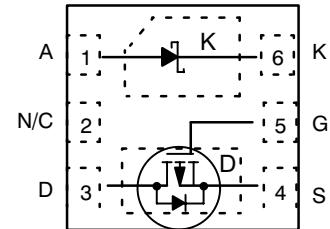
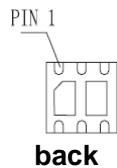
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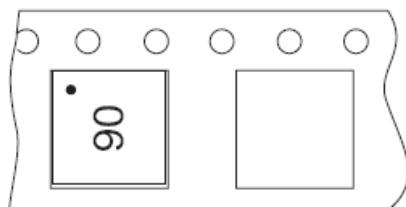
### MARKING:



PIN 1  
front



Tape Drawing (Unit : mm)



### MOSFET MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	
Continuous Drain Current	$I_D$	-2	A
Power Dissipation	$P_D$	0.7	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	178	$^\circ\text{C}/\text{W}$
Storage Temperature	$T_j$	150	$^\circ\text{C}$
Junction Temperature	$T_{stg}$	-55 ~+150	

MOSFET ELECTRICAL CHARACTERISTICS ( $T_a=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>On/Off Characteristics</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = -250\mu\text{A}$	-20			V
Gate-threshold voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-0.4		-1	
Gate-body leakage current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 8V$			$\pm 100$	nA
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -20V, V_{GS} = 0V$			-1	$\mu\text{A}$
Drain-source on-state resistance (note 1)	$R_{DS(\text{on})}$	$V_{GS} = -4.5V, I_D = -2.8\text{A}$			110	$\text{m}\Omega$
		$V_{GS} = -2.5V, I_D = -2.0\text{A}$			150	
Forward transconductance (note 1)	$g_{fs}$	$V_{DS} = -10V, I_D = -2.7\text{A}$	5.5			S
<b>Charges , Capacitances and Gate resistance</b>						
Input capacitance (note 2)	$C_{iss}$	$V_{DS} = -15V, V_{GS} = 0V, f = 1\text{MHz}$		480		$\text{pF}$
Output capacitance (note 2)	$C_{oss}$			46		
Reverse transfer capacitance (note 2)	$C_{rss}$			10		
Total gate charge	$Q_g$	$V_{DS} = -6V, V_{GS} = -4.5V, I_D = -2.8\text{A}$		7.2		$\text{nC}$
Gate-source charge	$Q_{gs}$			2.2		
Gate-drain charge	$Q_{gd}$			1.2		
<b>Switching times (note2)</b>						
Turn-on delay time	$t_{d(on)}$	$V_{DS} = -6V, R_L = 6\Omega, V_{GS} = -4.5V, R_{GEN} = 6\Omega$		38		$\text{ns}$
Rise time	$t_r$			25		
Turn-off delay time	$t_{d(off)}$			43		
Fall time	$t_f$			5		
<b>Source-drain diode characteristics</b>						
Forward on voltage (note1)	$V_{SD}$	$V_{GS} = 0V, I_S = -1\text{A}$			-1.4	V

**Notes:**

1. Pulse Test : Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
2. These parameters have no way to verify.

SCHOTTKY DIODE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Value		Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	20		V
DC blocking voltage	$V_R$		20	
Average rectified forward current	$I_F$	1		A

SCHOTTKY DIODE ELECTRICAL CHARACTERISTICS ( $T_a=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Forward voltage	$V_F$	$I_F = 0.1\text{A}$			0.4	
		$I_F = 0.5\text{A}$			0.5	
		$I_F = 1\text{A}$			0.575	
Reverse current	$I_R$	$V_R = 20V$			15	$\mu\text{A}$
		$V_R = 10V$			5	

